

PRODUCT	•	LCD MODULE
MODEL NO	:	LCD400KLAA-02-100C
SUPPLIER	:	LCD Mikroelektronik GmbH
DATE	:	Feb.25.2022

# **SPECIFICATION**

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1. General Specifications	4
2. Mechanical Drawing	5
3. PIN Assignment	6
4. Absolute Maximum Rating	
5. Electrical Characteristics	
5.1. Recommended Operating Condition	
5.2. Recommended Driving Condition for Backlight	
6. Timing Characteristics	
6.1. AC Electrical Characteristics	
6.2. DC Electrical Characteristics	
6.3. Reset Timing	13
6.4. Power ON/OFF Sequence	14
7. Optical Characteristics	15
8. Environmental/Reliability Test	18
9. Packing Drawing	19
10. Standard Specifications For Product Quality	
10.1. Manner of test	
10.2. Quality specification	
10.3. Definition of area	
10.4. Standard of appearance	21
11. Precautions for Use of LCD Modules	25
11.1. Handing Precautions	25
11.2. Storage Precautions	26
11.3. Others	26
11.4. USING LCD MODULES	26
11.5. The disposal of waste	28
12. Prior Consult Matter	28
13 Factory	28



# **Revision Record**

Rev No.	Rev Date	Contents	Remarks
1.0	2022.02.25	New creation	



Version: 1.0

# 1. General Specifications

No.	Item	Contents	Unit
1	Size	4.0	inch
2	Resolution	480RGB*480	
3	Interface	MIPI	
4	Color Depth	16	М
5	Technology Type	a-Si	
6	Pixel Pitch	0.1497 (H) x 0.1462 (V)	mm
7	Pixel Arrangement	R.G.B Vertical Stripe	
8	Display Mode	Normally Black, Transmissive, IPS	
9	Viewing Direction	ALL VIEW	
10	LCM (W x H x D)	83.6*83.6*4.19	mm
11	Active Area (W x H)	71.86*70.18	mm
12	With/Without TSP	With CTP	
13	LED Numbers	10	

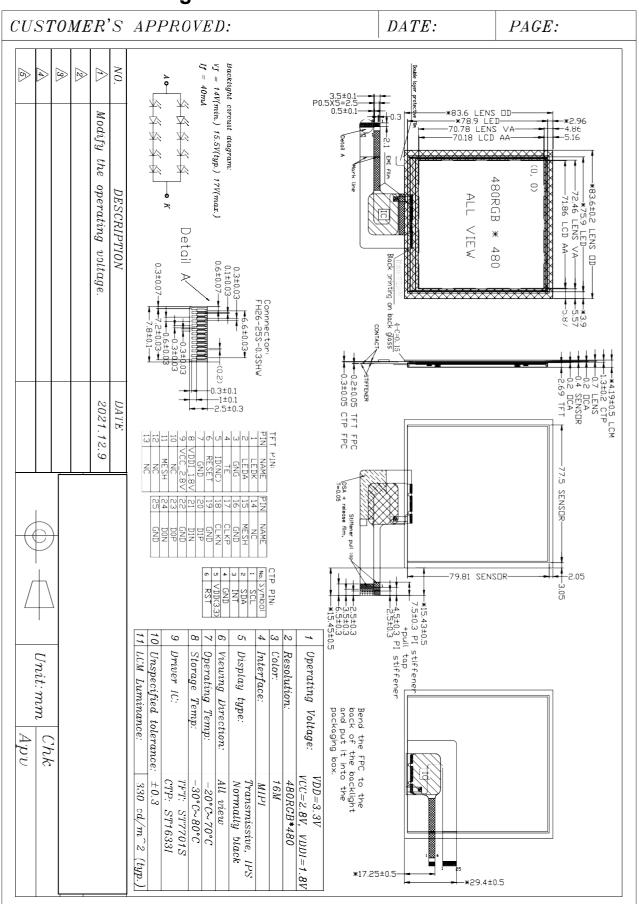
# **Touch Panel Parameter**

No.	Features	Details	Note
1	CTP Technology	Mutual capacitor	
2	Input Method	Finger	
3	Touch point	5 Point	
4	Positional Accuracy	2.5mm at 4 edges and 1.5mm at center	Unit: mm
5	Cover glass	Soda lime glass, chemically hardened	
6	Hardness	6H	
7	Surface treatment	NO	
8	Optical transmittance	87%	
9	Touch controller	ST1633i	
10	Interface to Host	l <sup>2</sup> C	
11	I2C Address	0X55	
12	Connection Type	ZIF Connector	

# 2. Mechanical Drawing

LCD

MIKROELEKTRONIK



# 3. PIN Assignment

Pin No.	Symbol	I/O	Function	Remark
1	LEDK	Р	LED cathode.	
2	LEDA	Р	LED anode.	
3	GND	Р	Ground.	
4	TE	-	For IC Test. Leave the pin open when not in use.	
5	ID(NC)	-	No connection	
6	RESET	I	The external reset input Initializes the chip with a low input. Be sure to execute a power-on reset after supplying power	
7	GND	Р	Ground.	
8	VDDI_1.8V	Р	Power Supply for I/O System.	
9	VCC_2.8V	Р	Power Supply for Analog, Digital System and Booster Circuit.	
10	NC	-	No connection.	
11	MESH	-	Connect to pin15.	
12	NC	-	No connection.	
13	NC	-	No connection.	
14	NC	-	No connection.	
15	MESH	-	Connect to pin11.	
16	GND	Р	Ground.	
17	CLKP	I	MIPI DSI differential clock pair. That the COG resistance is less than 10 ohm. If MIPI are not in use, they should be connected to GND	
18	CLKN	I	MIPI DSI differential clock pair. That the COG resistance is less than 10 ohm. If MIPI are not in use, they should be connected to GND	
19	GND	Р	Ground.	
20	D1P	I/O	MIPI DSI differential data pair. That the COG resistance is less than 10 ohm. If MIPI are not in use, they should be connected to GND	
21	D1N	I/O	MIPI DSI differential data pair. That the COG resistance is less than 10 ohm. If MIPI are not in use, they should be connected to GND	
22	GND	Р	Ground.	
23	D0P	I/O	MIPI DSI differential data pair. That the COG resistance is less than 10 ohm. If MIPI are not in use, they should be connected to GND	
24	DON	I/O	MIPI DSI differential data pair. That the COG resistance is less than 10 ohm. If MIPI are not in use, they should be connected to GND	
25	GND	Р	Ground.	

PS. For further details, please refer to ST7701S data sheet.



# 4. Absolute Maximum Rating

AGND = GND = 0V,Ta = 25°C

Item	Symbol	Min	Max	Unit	Remark
Power Voltage	VCC	-0.3	4.6	V	
Power Voltage	VDDI	-0.3	4.6	V	
Operating Temperature	$T_{OPR}$	-20	70	°C	
Storage Temperature	$T_{STG}$	-30	80	°C	

Note1: The absolute maximum rating values of this product are not allowed to be exceeded at any times. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be permanently destroyed.

### 5. Electrical Characteristics

### 5.1. Recommended Operating Condition

AGND = GND = 0V, Ta =  $25^{\circ}$ C

Item	Symbol	Min	Тур.	Max	Unit	Remark
Power Voltage	VCC	2.5	2.8	3.6	V	
Power Voltage	VDDI	1.65	1.8	3.3	V	
Input logic high voltage	Vih	0.7VDDI	-	VDDI	V	
Input logic low voltage	Vil	0	-	0.3 VDDI	V	

### 5.2. Recommended Driving Condition for Backlight

Ta = 25℃

Item	Symbol	Min	Тур.	Max	Unit	Remark
Forward Voltage	Vf	14.0	15.5	17.0	V	
Forward Current	If		40		mA	
Operating Life Time	-	30000			Hours	

Note 1: Ta means ambient temperature of TFT-LCD module.

Note 2: IF, VF are defined for one channel LED. There are two LED channel in back light unit.

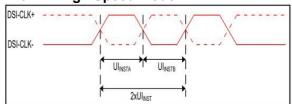
Note 3: If the module is driven by high current or at high ambient temperature & humidity condition. The operating life will be reduced

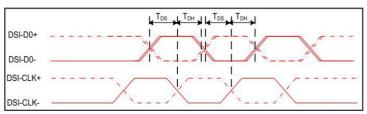
Note 4: Operating life means brightness goes down to 50% initial brightness. Minimum operating life time is estimated data.

# 6. Timing Characteristics

### 6.1. AC Electrical Characteristics

### 6.1.1. High Speed Mode





DSI clock channel timing

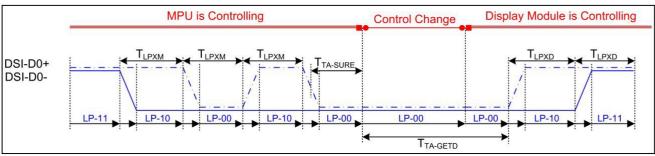
### Rising and falling time on clock and data channel

VDDI=1.8,VCC=2.8, AGND=DGND=0V, Ta=25°C

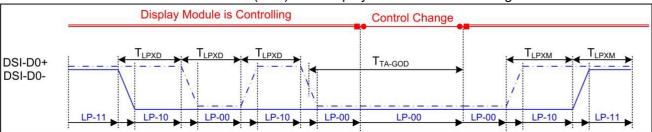
Signal	Symbol	Parameter	MIN	MAX	Unit	Description
DSI-CLK+/-	2xUI <sub>INSTA</sub>	Double UI instantaneous	4	25	ns	
DSI-CLK+/-	UI <sub>INSTA</sub> UI <sub>INSTB</sub>	UI instantaneous halfs	2	12.5	ns	UI = UI <sub>INSTA</sub> = UI <sub>INSTB</sub>
DSI-Dn+/-	tDS	Data to clock setup time	0.15	13-23	Ül	
DSI-Dn+/-	tDH	Data to clock hold time	0.15		UI	

Mipi Interface- High Speed Mode Timing Characteristics

### 6.1.2. Lowe Power Mode



Bus Turnaround (BTA) from display module to MPU Timing



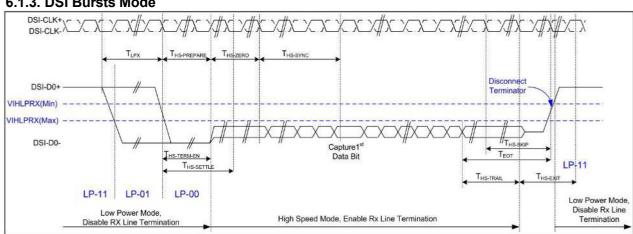
Bus Turnaround (BTA) from MPU to display module Timing

Fe	h	25	20	22
10	ν.			

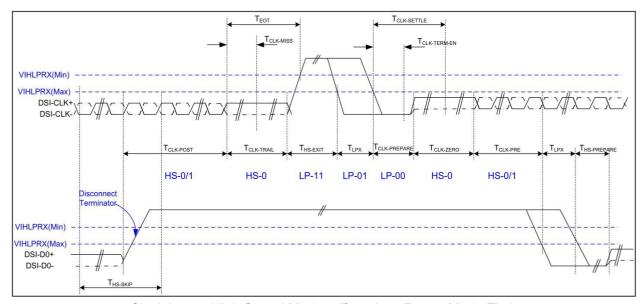
Signal	Symbol	Parameter	MIN	MAX	Unit	Description
		Length of LP-00,LP-01,				
DSI-D0+/-	TLPXM	LP-10 or LP-11 periods	50	75	ns	Input
		MPU→Display Module				
		Length of LP-00,LP-01,				
DSI-D0+/-	TLPXD	LP-10 or LP-11 periods	50	75	ns	Output
		MPU→Display Module				
DSI-D0+/-	TTA-SURED	Time-out before the MPU	  -	2xT <sub>LP</sub>		Outnut
D9I-D0+/-	I IA-SURED	start driving	LPXD		ns	Output
DSI-D0+/-	TTA-GETD	Time to drive LP-00 by	EVT			lanut
D9I-D0+/-	I IA-GEID	display module	j sxi	LPXD	ns	Input
DSI-D0+/-	TTA-GOD	Time to drive LP-00 after	4vT	4xT <sub>LPXD</sub>		Outnut
טטו-וטט+/-	I IA-GOD	turnaround request-MPU	4 4 1	LPXD	ns	Output

Mipi Interface Low Power Mode Timing Characteristics

### 6.1.3. DSI Bursts Mode



Data lanes-Low Power Mode to/from High Speed Mode Timing



Clock lanes- High Speed Mode to/from Low Power Mode Timing

### VDDI=1.8,VCC=2.8, AGND=DGND=0V, Ta=25 $^{\circ}$ C

Feb.25.2022

	I .	V D D I =	1.0, 000	,- <u>2.</u> 0, A	GIND-DG	6ND=0V, Ta=25 (
Signal	Symbol	Parameter	MIN	MAX	Unit	Description
	I	ow Power Mode to High Speed M	ode Timi	ng		
DSI-Dn+/-	TLPX	Length of any low power state period	50	-	ns	Input
DSI-Dn+/-	THS-PREPARE	Time to drive LP-00 to prepare for HS transmission	40+4 UI	85+6 UI	ns	Input
DSI-Dn+/-	THS-TERM-EN	Time to enable data receiver line termination measured from when Dn crosses VILMAX	-	35+4 UI	ns	Input
DSI-Dn+/-	THS-PREPARE + THS-ZERO	THS-PREPARE + time to drive HS-0 before the sync sequence	140+ 10UI	-	ns	Input
	ı	High Speed Mode to Low Power M	ode Timi	ng		
DSI-Dn+/-	THS-SKIP	Time-out at display module to ignore transition period of EoT	40	55+4 UI	ns	Input
DSI-Dn+/-	THS-EXIT	Time to drive LP-11 after HS burst	100	-	ns	Input
DSI-Dn+/-	THS-TRAIL	Time to drive flipped differential state after last payload data bit of a HS transmission burst	60+4 UI	-	ns	Input
	Hig	h Speed Mode to/from Low Power	Mode Ti	ming		
DSI-CLK+/-	TCLK-POS	Time that the MPU shall continue sending HS clock after the last associated data lane has transition to LP mode	60+5 2UI	-	ns	Input
DSI-CLK+/-	TCLK-TRAIL	Time to drive HS differential state after last payload clock bit of a HS transmission burst	60	-	ns	Input
DSI-CLK+/-	THS-EXIT	Time to drive LP-11 after HS burst	100	-	ns	Input
DSI-CLK+/-	TCLK-PREPARE	Time to drive LP-00 to prepare for HS transmission	38	95	ns	Input
DSI-CLK+/-	TCLK-TERM-EN	Time-out at clock lan display module to enable HS transmission		38	ns	Input
DSI-CLK+/-	TCLK-PREPARE + TCLK-ZERO	Minimum lead HS-0 drive period before starting clock	300	-	ns	Input
DSI-CLK+/-	TCLK-PRE	Time that the HS clock shall be driven prior to any associated data lane beginning the transition from LP to HS mode	8UI	-	ns	Input
DSI-CLK+/-	TEOT	Time form start of TCLK-TRAIL period to start of LP-11 state	-	105n s+12 UI	ns	Input



Version: 1.0

### 6. 2. DC Electrical Characteristics

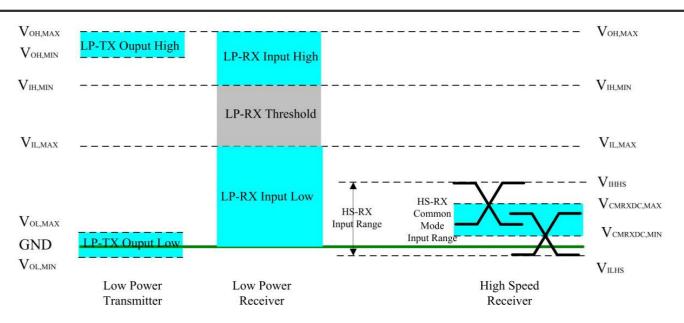
<b>B</b>	Our to a	C1'''	S	pecification	on	11. 24	Related	
Parameter	Symbol	Condition	MIN.	TYP.	MAX.	Unit	Pins	
		Power & Operation	Voltage	2.				
System Voltage	vcc	Operating voltage	2.5	2.8	3.6	٧		
Interface Operation Voltage	VDDI	I/O Supply Voltage	1.65	1.8	3.3	٧		
Gate Driver High Voltage	VGH		11.5		17	V		
Gate Driver Low Voltage	VGL		-7.6		-12	V		
Gate Driver Supply Voltage		VGH-VGL	5		30	V		
		Input / Outp	ut		15		\$40°	
Logic-High Input Voltage	VIH		0.7VDDI		VDDI	٧	Note 1	
Logic-Low Input Voltage	VIL		VSS		0.3VDDI	V	Note 1	
Logic-High Output Voltage	VOH	IOH = -1.0mA	0.8VDDI		VDDI	V	Note 1	
Differential Input High Threshold Voltage	VIT+			0	50	mV		
Differential Input Low Threshold Voltage	VIT-		-50	0		mV	MIPI_CLK MIPI_Data	
Single-ended Receiver Input Operation Voltage Range	VIR		0.5		1.2	٧		
Logic-Low Output Voltage	VOL	IOL = +1.0mA	VSS		0.2VDDI	٧	Note 1	
Logic-High Input Current	IIH	VIN = VDDI			1	uA	Note 1	
Logic-Low Input Current	IIL	VIN = VSS	-1			uA	Note 1	
Input Leakage Current	IIL	IOH = -1.0mA	-0.1		0.1	uA	Note 1	
-		VCOM Volta	ge		the state of the s	:	u s	
VCOM amplitude	VCOM			VSS		٧		
3	5	Source Driv	er		<u> </u>			
Gamma Reference Voltage(Positive)	VAP		4.4		6.4	٧		
Gamma Reference Voltage(Negative)	VAN		-2.6		-4.6	٧		
Source Output Settling Time	Tr	Below with 99% precision			10	us	Note 2	

**Basic DC Characteristics** 

Note1: Typical: VDDI=1.8V, VDD=2.8V; Ta=25  $^{\circ}$ C

Note2: The Max. value is between measured point of source output and gamma setting value.

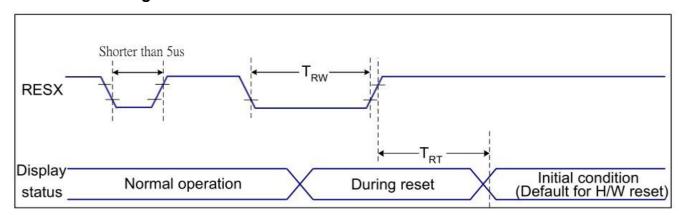
Note3: When evaluating the maximum and minimum of VGH, VDD=2.8V. Note4: The maximum value of |VGH-VGL| can no over 30V.



### VDDI=1.8,VCC=2.8, AGND=DGND=0V, Ta=25℃

Parameter	Symbol			Unit	
Parameter	Symbol	MIN	TYP	MAX	Unit
Operation	o Voltage for I	MIPI Receiver			
Low power mode operating voltage	VLPH	1.1	1.2	1.3	V
MIPI Characte	ristics for High	Speed Rece	iver		
Single-ended input low voltage	V ILHS	-40	-	-	mV
Single-ended input high voltage	V <sub>IHHS</sub>	-	-	460	mV
Common-mode voltage	VCMRXDC	70	-	330	mV
Differential input impedance	Zιο	80	100	125	ohm
MIPI Charac	teristics for Lo	ow Power Mod	de		
Pad signal voltage range	Vı	-50	-	1350	mV
Logic 0 input threshold	VIL	0-	-	550	mV
Logic 1 input threshold	Vн	880	-	1350	mV
Output low level	<b>V</b> ol	-50	-	50	mV
Output high level	Vон	1.1	1.2	1.3	V

### 6. 3. Reset Timing



### VDDI=1.8,VCC=2.8, AGND=DGND=0V, Ta=25°C

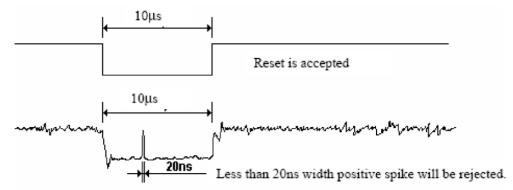
Version: 1.0

Related Pins	Symbol	Parameter	MIN	MAX	Unit
	TRW	Reset pulse duration	10	-	us
RESX	TRT Reset cancel	Deset sensel	-	5 (Note 1, 5)	ms
			120(Note 1, 6, 7)	ms	

- Note 1. The reset cancel includes also required time for loading ID bytes, VCOM setting and other settings from NVM (or similar device) toregisters. This loading is done every time when there is HW reset cancel time (tRT) within 5 ms after a rising edge of RESX.
- Note 2. Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below:

RESX Pulse	Action
Shorter than 5us	Reset Rejected
Longer than 9us	Reset
Between 5us and 9us	Reset starts

- Note 3. During the Resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In –mode.) and then return to Default conditionfor Hardware Reset.
- Note 4. Spike Rejection also applies during a valid reset pulse as shown below:



- Note 5. When Reset applied during Sleep In Mode.
- Note 6. When Reset applied during Sleep Out Mode.
- Note 7. It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.

Version: 1.0

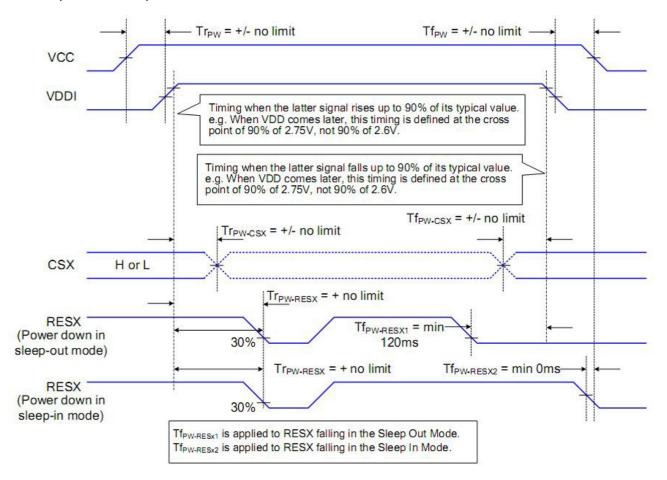
### 6. 4. Power ON/OFF Sequence

VDDI and VCC can be applied or powered down in any order. During the Power Off sequence, if the LCD is in theSleep Out mode, VCC and VDDI must be powered down with minimum 120msec. If the LCD is in the Sleep Inmode, VCC and VDDI can be powered down with minimum 0msec after the RESX is released.

CSX can be applied at any timing or can be permanently grounded. RESX has high priority over CSX.

- Note 1: There will be damage to the LCM if the power sequences are not met.
- Note 2: There will be no abnormal visible effects on the display panel during the Power On/Off Sequences.
- Note 3: There will be no abnormal visible effects on the display between the end of Power On Sequence and beforereceiving the Sleep Out command, and also between receiving the Sleep In command and the Power Off Sequence.

The power on/off sequence is illustrated below



#### **Uncontrolled Power Off**

The uncontrolled power-off means a situation which removed a battery without the controlled power off sequence. It will neither damage the module or the host interface.

If uncontrolled power-off happened, the display will go blank and there will not any visible effect on the display (blank display) and remains blank until "Power On Sequence" powers it up.

Version: 1.0

# 7. Optical Characteristics

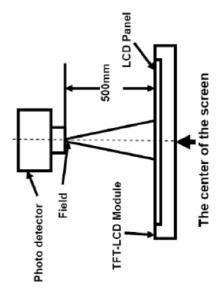
Item		Symbol	Condition	Min	Тур	Max	Unit	Remark
		θТ		70 80 -				
Viou Anal	00	θВ	CR≥10	70	80	-	Dograd	Note 2
View Angl	es	θL	CR210	70	80	-	Degree	Note 2
		θR		70	80	-		
Contrast Ra	atio	CR	$\theta = 0^{\circ}$	(640)	(800)	•		Note 1 Note 3
Response T	ime	$T_{ON+}T_{OFF}$	25°C	-	25	35	ms	Note 1 Note 4
	W <sub>x</sub>	Х		(0.230)	(0.270)	(0.310)		Note 1
	Wy	у		(0.264)	(0.304)	(0.344)		Note 5
	R <sub>x</sub>	Х		(0.572)	(0.612)	(0.652)		
Chromaticity	Ry	у		(0.310)	(0.350)	(0.390)		
Chromaticity	G <sub>x</sub>	Х		(0.263)	(0.303)	(0.343)		
	Gy	у		(0.551)	(0.591)	(0.631)		
	B <sub>x</sub>	Х		(0.100)	(0.140)	(0.180)		
	Ву	у		(0.043)	(0.083)	(0.123)		
Uniformit	у	U		75	-	-	%	Note 5
Luminand	e	L		-	330	-	cd/m <sup>2</sup>	Note 1 Note 5

**Test Conditions:** 

- 1. If=40mA(Backlight current), VCC = 2.8 V, the ambient temperature is  $25^{\circ}C$ .
- 2. The test systems refer to Note 2.

#### Note1: Definition of optical measurement system.

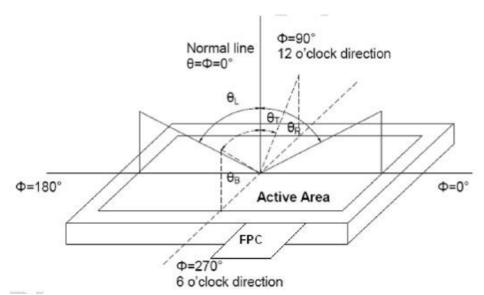
The optical characteristics should be measured in dark room. After 5Minutes operation, the optical properties are measured at the center point of the LCD screen. ALL input terminals LCD panel must be ground when measuring the center area of the panel.



Item	Photo detector	Field
Contrast Ratio		
Luminance	CS1000	1°
Lum Uniformity		
Chromaticity	CS1000	
Response Time	DMS703	-

Note2: Definition of viewing angle range and measurement system.

Viewing angle is measured at the center point of the LCD by CONOSCOPE (DMS703)



Note3: Definition of contrast ratio

White state ":The state is that the LCD should drive by Vwhite.

Contrast ratio(CR)= Luminance measured when LCD is on the "White" state

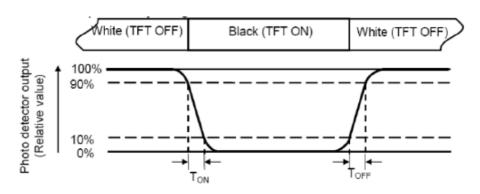
Luminance measured when LCD is on the "Black" state

"Black state": The state is that the LCD should drive by Vblack.

Vwhite: To be determined Vblack: To be determined

#### Note4: Definition of Response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time  $(T_{ON})$  is the time between photo detector output intensity changed from 90% to 10%. And fall time  $(T_{OFF})$  is the time between photo detector output intensity changed from 10% to 90%.



Note5: Definition of color chromaticity (CIE1931)

Color coordinates measured at center point of LCD.

Color coordinates are subject to actual measurement.

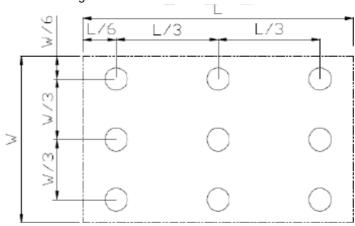
If the data has a bracket, that means reference value of TFT panel or one sample of module, the values of module TBD.

Note6: Definition of Luminance Uniformity

Active area is divided into 9 measuring areas (Refer Fig.2). Every measuring point is placed at the center of each measuring area.

Luminance Uniformity (U)=Lmin/Lmax

L-Active area length W-Active area width



L max: The measured Maximum luminance of all measurement position.

L min: The measured Minimum luminance of all measurement position.

Note7: Definition of luminance: Measure the luminance of white state at center point.



Version: 1.0

# 8. Environmental/Reliability Test

No.	Test Item	Test Condition	Inspection after test
1	High Temperature Storage	80±2℃/240 hours	
2	Low Temperature Storage	-30±2°C/240 hours	
3	High Temperature Operating	70±2℃/240 hours	
4	Low Temperature Operating	-20±2°C/240 hours	
5	Temperature Cycle	-30℃~ 25℃~ 80℃ × 10cycles (30min.) (5min.) (30min.)	Inspection after 2~4hours storage at room temperature, the sample
6	Damp Proof Test	40℃±5℃×90%RH/240 hours	shall be free from defects:  1.Air bubble in the LCD;
7	Vibration Test	Frequency: 10Hz~55Hz~10Hz  Amplitude: 1.5mm,  X, Y, Z direction for total 3hours  (Packing condition)	2.Sealleak; 3.Non-display; 4.Missing segments; 5.Glass crack; 6.Current Idd is twice
8	Dropping test	Drop to the ground from 1m height, one time, every side of carton. (Packing condition)	higher than initial value.
9	ESD test	Voltage:±8KV R: 330Ω C: 150pF Air discharge, 10time Voltage:±6KV R: 330Ω C: 150pF Contact discharge, 10time	

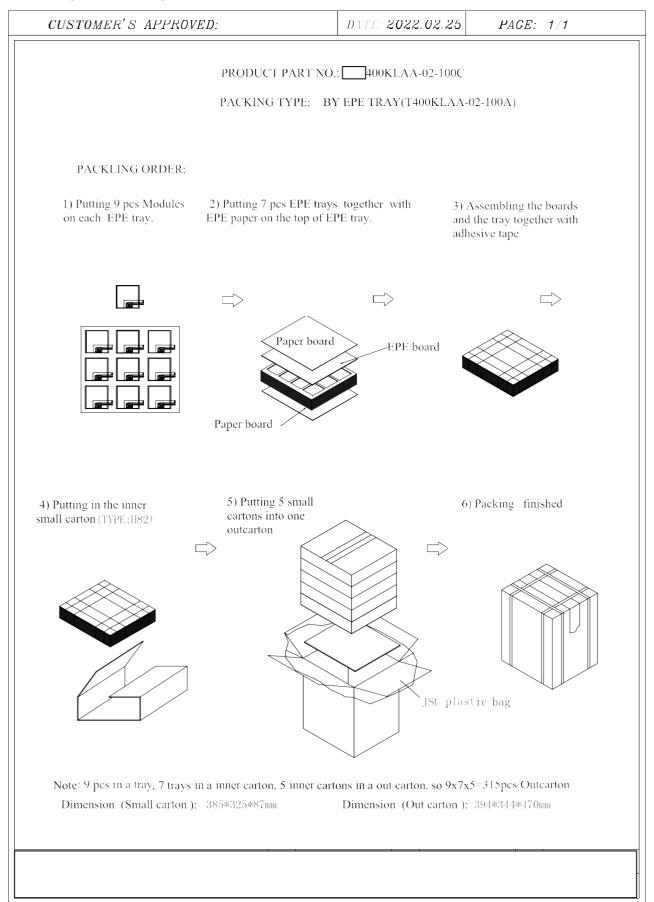
### Remark:

- 1. The test samples should be applied to only one test item.
- 2. Sample size for each test item is 5~10pcs.
- 3. For Damp Proof Test, Pure water (Resistance>10M $\Omega$ ) should be used.
- 4. In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judge as a good part.
- 5. Failure Judgment Criterion: Basic Specification, Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.
- 6. Please use automatic switch menu (or roll menu) testing mode when test operating mode.

Feb.25.2022



# 9. Packing Drawing





Version: 1.0

# 10. Standard Specifications For Product Quality

### 10.1. Manner of test:

- 10.1.1 The test must be under 40W fluorescent light, and the distance of view must be at 35±5cm
- 10.1.2 Room temperature 25±5℃ Humidity: (65±5)%RH.
- 10.1.3 If the product is uneven and bright spot, use 2%ND filter to check and confirm. Not visible, OK.
- 10.1.4 Inspection Angle:

The vision of inspector should be perpendicular to the surface of the Module.

10.1.5 Inspection time:

Perceptibility Test Time: 20 seconds max.

### 10.2. Quality specification

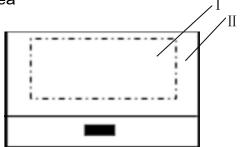
It shall be based on GB2828, inspection level II.

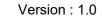
	IETM	CHECK LEVEL	AQL
MAJOR (MA)	<ol> <li>Liquid crystal leakage</li> <li>Wrong polarizer</li> <li>Outside dimension</li> <li>Bright dot, Dark dot</li> <li>Display abnormal</li> <li>Class crack</li> </ol>	II	0.65
MINOR (MI)	<ol> <li>Spot Defect (Including black spot,white spot,pinhole,foreign particle,bubbles,hurt)</li> <li>Fragment</li> <li>Line Defect (Including black line,white line,scratch)</li> <li>Incision defect</li> <li>Newton's ring</li> <li>Other visual defects</li> </ol>	II	1.0

### 10.3 Definition of area

10.3.1 I area: viewing area

" area: outside viewing area





# 10.4. Standard of appearance test for I area: (unit: mm)

NOTE: Defect ignore for II area.

10.4.1 Bright/Dark Dots explain

Name	Explain	Definition
Bright dot	Dots appear bright and unchanged in size in which LCD panel is displaying under black pattern.	The definition of dot: The size of a defective dot over 1/2 of single pixel dot is
Dark dot	Dots appear dark and unchanged in size in which LCD panel is displaying under pure red, green, blue pattern.	regarded as one defective dot .  Note:One pixel consists of 3 sub-pixels, including R,G, and B dot.(Sub-pixel = Dot)
Adjacent Dot	Adjacent two sub-pixel are defect (define two dot defect)	

10.4.2 Inspection standard

10.4.2	Inspection standard						
No	Items	Criterion			Checking manner	Defect classes	
1	Bright/dark dot	5mm	4.3" <lcd<7" bright="" dark="" defections<="" dot:="" etween="" n≤3="" n≤4="" n≤6="" td="" the="" total:="" two=""><td></td><td>· ·</td><td>Checking with eyes</td><td>MAJ</td></lcd<7">		· ·	Checking with eyes	MAJ
2	Spot defects (black and white spot, pinhole, foreign matter, dent, backlight foreign matter)	D≤0.15 Ignore 0.15 <d≤0.3 N≤3 0.3<d n="0&lt;/td"><td>D≤0.2 Ignore 0.2 <d≤0.5 N≤4 0.5<d n="0&lt;/td"><td>D≤0.2 Ignore 0.2 <d≤0.5 N≤5 0.5<d n="0&lt;/td"><td>D≤0.2 Ignore 0.2 <d≤0.5 N≤6 0.5<d n="0&lt;/td"><td>Checking with eyes</td><td>MIN</td></d></d≤0.5 </td></d></d≤0.5 </td></d></d≤0.5 </td></d></d≤0.3 	D≤0.2 Ignore 0.2 <d≤0.5 N≤4 0.5<d n="0&lt;/td"><td>D≤0.2 Ignore 0.2 <d≤0.5 N≤5 0.5<d n="0&lt;/td"><td>D≤0.2 Ignore 0.2 <d≤0.5 N≤6 0.5<d n="0&lt;/td"><td>Checking with eyes</td><td>MIN</td></d></d≤0.5 </td></d></d≤0.5 </td></d></d≤0.5 	D≤0.2 Ignore 0.2 <d≤0.5 N≤5 0.5<d n="0&lt;/td"><td>D≤0.2 Ignore 0.2 <d≤0.5 N≤6 0.5<d n="0&lt;/td"><td>Checking with eyes</td><td>MIN</td></d></d≤0.5 </td></d></d≤0.5 	D≤0.2 Ignore 0.2 <d≤0.5 N≤6 0.5<d n="0&lt;/td"><td>Checking with eyes</td><td>MIN</td></d></d≤0.5 	Checking with eyes	MIN
3	Bubble  Tr  D=(X+Y)/2	D≤0.2 Ignore 0.2 <d≤0.5 N≤3 0.5<d n="0&lt;/td"><td>D≤0.2 Ignore 0.2 <d≤0.5 N≤4 0.5<d n="0&lt;/td"><td>D≤0.2 Ignore 0.2 <d≤0.5 N≤5 0.5<d n="0&lt;/td"><td>D≤0.2 Ignore 0.2 <d≤0.5 N≤6 0.5<d n="0&lt;/td"><td></td><td></td></d></d≤0.5 </td></d></d≤0.5 </td></d></d≤0.5 </td></d></d≤0.5 	D≤0.2 Ignore 0.2 <d≤0.5 N≤4 0.5<d n="0&lt;/td"><td>D≤0.2 Ignore 0.2 <d≤0.5 N≤5 0.5<d n="0&lt;/td"><td>D≤0.2 Ignore 0.2 <d≤0.5 N≤6 0.5<d n="0&lt;/td"><td></td><td></td></d></d≤0.5 </td></d></d≤0.5 </td></d></d≤0.5 	D≤0.2 Ignore 0.2 <d≤0.5 N≤5 0.5<d n="0&lt;/td"><td>D≤0.2 Ignore 0.2 <d≤0.5 N≤6 0.5<d n="0&lt;/td"><td></td><td></td></d></d≤0.5 </td></d></d≤0.5 	D≤0.2 Ignore 0.2 <d≤0.5 N≤6 0.5<d n="0&lt;/td"><td></td><td></td></d></d≤0.5 		

No	Items	Criterion			Checking manner	Defect classes	
	Line defects(black	LCD≤4.3"	4.3" <lcd< 7"</lcd< 	7"≤LCD≤12"	LCD>12"		
4	and white line, backlight foreign matter etc.)	W≤0.03 Ignore 0.03 < W≤0.06 L≤5 N≤3 W >0.06 L>5 N=0	W≤0.03 Ignore 0.03 <w≤0.1 L≤5 N≤4 W &gt;0.1 L&gt;5 N=0</w≤0.1 	W≤0.03 Ignore 0.03 <w≤0.1 L≤5 N≤5 W &gt;0.1 L&gt;5 N=0</w≤0.1 	W≤0.03 Ignore 0.03 <w≤0.1 L≤5 N≤6 W &gt;0.1 L&gt;5 N=0</w≤0.1 	Checking with eyes	MIN
5	Scratch	W≤0.03 Ignore 0.03 <w≤0.2 1.0<l≤ 5.0<br="">N≤3 W&gt;0.2 L&gt;5 N=0</l≤></w≤0.2 	W≤0.03 Ignore 0.03 <w≤0.2 1.0<l≤ 5.0<br="">N≤4 W&gt;0.2 L&gt;5 N=0</l≤></w≤0.2 	W≤0.03 Ignore 0.03 <w≤0.2 1.0<l≤ 5.0<br="">N≤5 W&gt;0.2 L&gt;5 N=0</l≤></w≤0.2 	W≤0.03 Ignore 0.03 <w≤0.2 1.0<l≤ 5.0<br="">N≤6 W&gt;0.2 L&gt;5 N=0</l≤></w≤0.2 	Checking with eyes	MIN
6	Display abnormal	Not allowed		Checking with eyes	MAJ		
7	Outside dimension	Accord with drawing		Calipers	MAJ		
8	Glass crack	Not allowed				Checking with eyes	MAJ
9	Leak	Not allowed		Checking with eyes	MAJ		
10	Comer and side fragment	崩角 ス・・・・・・・・・・・・・・・・・・・・・・・・・・・・・・・・・・・・	崩边 <sup>t</sup> z	<ol> <li>Comer fraging X</li></ol>	≤1mm Z≤T/2	Calipers& Eyes	MIN
11	Crack			No	G	Eyes	MAJ
12	Newton's ring (CTP or Cover board)		<u>.</u>	Newton's ring< lightened ,no infl words and lines		Checking with eyes	MIN

LCD MODULE LCD400KLAA-02-100C Version : 1.0

### TP 标准

No No	Items	Phenomenon/picture	Criterion	Checking manner	Defect class
1	Outside dimension		Accord with drawing	Calipers& Eyes	MIN
2	Color deviation	Difference of ink color	Obvious deviation compared with samples	Eyes	MIN
3	Ink pinhole	油墨针孔	No any holes near VA side 3mm Out of VA: D≤0.15mm N≤1 ,no present in reflection condition.	Eyes Film	MIN
4	Ink saw tooth	印刷锯齿	W≤0.15mm N=1	Eyes Film	MIN
5	Ink light leakage	油墨漏光	width of light leakage at the edge area ≤0.15mm OK     width of light leakage at the edge area >0.15mm NG	Eyes Film	MIN
6	Cover glass profile		No ink, adhesive, oil stain, etc.	Eyes	MIN
7	IR(LED)dot/black- white dot		φ≤0.2、N≤1 0.15 < φ、not allowed	Eyes& Film	MIN
8	IR(LED)dot black- white dot/different color		no present when use all viewing angle to determine at 35cm ,allowed	Eyes	MIN
9	Shooting hole	***************************************	φ≤0.2、N≤1 0.15 < φ、not allowed	Eyes& Film	MIN

Feb.25.2022

10	LOGO/ICON black-white dot	U	Diagram clear φ≤0.2、N≤1	Eyes& Film	MIN
11	FPC warped	FPC翘曲	ОК	Eyes	MIN
12	FPC broken, stained, oxidation	FPC折伤	NG	Eyes	MAJ
13	Stain		No evident finger print, oil print, gelatinoids, etc.	Eyes	MIN
14	Sponge		Presented in AA area. NG	Eyes	MIN
15	Protection foil	Finished Protection foil	1. Protection foil stain: In normal inspection condition ,finger print, pen print and gelatinoids are presented. NG  2. Bubble≤5.0mm ,or according to client's limited sample  3. Protection foil worn and warped。 NG  4. Scratch: W≤0.10mm , ignore length: 0.10mm < W≤0.20mm, L≤30mm, and N≤4,d>15mm; OK;L>30mm or W>0.20mm;NG	Eyes& Film	MIN

Version: 1.0

### 11. Precautions for Use of LCD Modules

### 11.1 Handing Precautions

- (1) The display panel is made of glass and polarizer. As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring. Do not subject it to a mechanical shock by dropping it or impact.
- (2) If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
- (3) Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. Do not touch the display with bare hands. This will stain the display area and degraded insulation between terminals (some cosmetics are determined to the polarizer).
- (4) The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. Do not touch, push or rub the exposed polarizer with anything harder than an HB pencil lead (glass, tweezers, etc.). Do not put or attach anything on the display area to avoid leaving marks on. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizer. After products are tested at low temperature they must be warmed up in a container before coming is contacting with room temperature air.
- (5) If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents
  - Isopropyl alcohol
  - Ethyl alcohol
  - Do not scrub hard to avoid damaging the display surface.
- (6) Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.
  - Water
  - Ketone
  - Aromatic solvents

Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading. Avoid contacting oil and fats.

- (7) Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- (8) Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I O cable or the backlight cable.
- (9) Do not attempt to disassemble or process the LCD module.
- (10) NC terminal should be open. Do not connect anything.
- (11) If the logic circuit power is off, do not apply the input signals.
- (12) Electro-Static Discharge Control, Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
  - Before remove LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential. Be sure to ground the body when handling the LCD modules.
  - Tools required for assembling, such as soldering irons, must be properly grounded. make certain the AC power source for the soldering iron does not leak. When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.
  - To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions. To reduce the generation of static electricity be careful that the air in the work is not too dried. A relative humidity of 50%-60% is recommended. As far as possible make the electric potential of your work clothes and that of the work bench the ground potential.

The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.



(13) Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.

- Do not alter, modify or change the shape of the tab on the metal frame.
- Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
- Do not damage or modify the pattern writing on the printed circuit board.
- Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.
- Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
- Do not drop, bend or twist LCM.

### 11.2Storage Precautions

When storing the LCD modules, the following precaution is necessary.

- (1) Store them in a sealed polyethylene bag. If properly sealed, there is no need for the dessicant.
- (2) Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0℃ and 35℃.
- (3) The polarizer surface should not come in contact with any other objects. (We advise you to store them in the container in which they were shipped).

### 11.3 Others

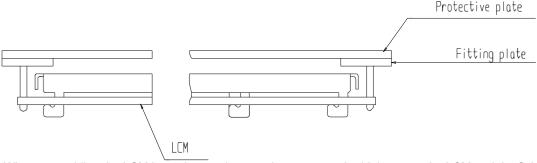
- (1) Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.
- (2) If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.
- (3) To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.
  - Exposed area of the printed circuit board.
  - -Terminal electrode sections.

#### 11.4 USING LCD MODULES

### **Installing LCD Modules**

The hole in the printed circuit board is used to fix LCM as shown in the picture below. Attend to the following items when installing the LCM.

(1) Cover the surface with a transparent protective plate to protect the polarizer and LC cell.



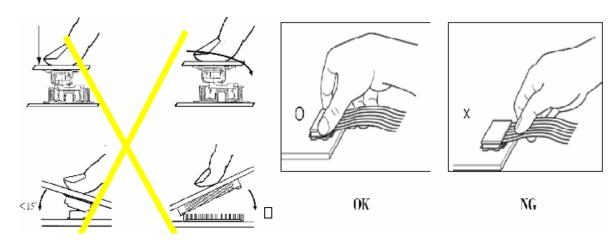
(2) When assembling the LCM into other equipment, the spacer to the bit between the LCM and the fitting plate should have enough height to avoid causing stress to the module surface, refer to the individual specifications for measurements. The measurement tolerance should be 0.1mm.



Version: 1.0

#### Precaution for assemble the module with BTB connector:

Please note the position of the male and female connector position, don't assemble or assemble like the method which the following picture shows



### Precaution for soldering to the LCM

	Hand soldering	Machine drag soldering	Machine press soldering
No ROHS Product	290 C~350 C.	330 C ~350 C. Speed : 4-	300 C~330C.
Product	Time :3-5S.	8mm/s.	Time : 3-6S.
			Press: 0.8~1.2Mpa
ROHS Product	340 C~370 C.	350 C ~370 C. Time : 4-8	330 C~360C.
Floudet	Time:3-5S.	mm/s.	Time : 3-6S.
			Press: 0.8~1.2Mpa

- (1) If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation. (This does not apply in the case of a non-halogen type of flux.) It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.
- (2) When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.
- (3) When remove the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged.

### **Precautions for Operation**

- (1) It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life. An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- (2) Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operating temperature.
- (3) If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.
- (4) A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit. Usage under the maximum operating temperature,50%RH or less is required.
- (5) Input each signal after the positive/negative voltage becomes stable.
- (6) Please keep the temperature within specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.

#### Safety

- (1) It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.
- (2) If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.

### 11.5The disposal of waste

For waste disposal, our recommendations are as follows, please refer to your company, and the relevant provisions of the state laws and regulations of the act accordingly

- 1. Packing materials disposal for our packaging (carton/PS tray/EPE tray/PET tray)
  - 1) Our company used to recycle and reuse materials, packing materials can be you just need to transfer to material recycling companies
- 2. Our scrap module can't be recycled for reuse, so please dispose of:
  - 1) Our scrap module can't be recycled for reuse, products and components are "served" can lead to accidents
  - 2) Our scrap can be transfer to material recycling companies, dismantling, to ensure that scrap in relatively advanced technology products, environmental protection measures of relatively perfect environment for processing.
- 3. WEEE order must be executed in product scrap.

### 12. Prior Consult Matter

- 1. (1) For standard products, we keep the right to change material, process...for improving the product property without notice on our customer.
- (2) For OEM products, if any change needed which may affect the product property, we will consult with our customer in advance.
- 2. If you have special requirement about reliability condition, please let us know before you start the test on our samples.

# 13. Factory

FACTORY NAME: LCD Mikroelektronik GmbH

FACTORY ADDRESS: Otto-Lilienthal-Str. 13, D-76275 Ettlingen